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### (54) PRESSURE-SENSITIVE ADHESIVE COMPOSITION

(57)Abstract:

PURPOSE: To obtain a pressure-sensitive adhesive excellent in a balance between tackiness and holding power and excellent in adhesiveness.

CONSTITUTION: The adhesive composition mainly consists of an epoxy-modified block copolymer prepared by epoxidizing the conjugated diene component of a block copolymer composed of a polymer block based on a vinylaromatic compound and a polymer block based on a conjugated diene compound and a tackifying resin. This composition is effectively used pressure-sensitive tapes or labels, thin pressure-sensitive adhesive plates, back pastes for fixing lightweight plastic moldings, back pastes for fixing carpets and pastes for fixing tiles and is effectively used for particularly pressure-sensitive adhesive tapes or labels.

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